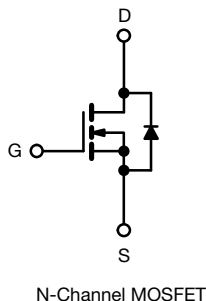
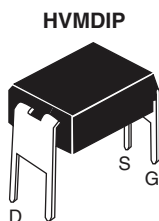


Power MOSFET



N-Channel MOSFET

FEATURES

- Dynamic dV/dt rating
- For automatic insertion
- End stackable
- Logic-level gate drive
- $R_{DS(on)}$ specified at $V_{GS} = 4\text{ V}$ and 5 V
- $175\text{ }^{\circ}\text{C}$ operating temperature
- Fast switching
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



PRODUCT SUMMARY

V_{DS} (V)	60	
$R_{DS(on)}$ (Ω)	$V_{GS} = 5\text{ V}$	0.20
Q_g (Max.) (nC)	8.4	
Q_{gs} (nC)	2.6	
Q_{gd} (nC)	6.4	
Configuration	Single	

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertible case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION

Package	HVMDIP
Lead (Pb)-free	IRLD014PbF

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	60	V
Gate-source voltage			V _{GS}	± 10	
Continuous drain current	V _{GS} at 5.0 V	T _A = 25 °C	I _D	1.7	A
		T _A = 100 °C		1.2	
Pulsed drain current ^a			I _{DM}	14	
Linear derating factor				0.0083	W/°C
Single pulse avalanche energy ^b			E _{AS}	490	mJ
Maximum power dissipation	T _A = 25 °C		P _D	1.3	W
Peak diode recovery dV/dt ^c			dV/dt	4.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	- 55 to + 175	°C
Soldering recommendations (peak temperature)	For 10 s			300 ^d	

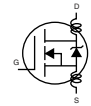
Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- $V_{DD} = 25\text{ V}$, starting $T_J = 25\text{ }^{\circ}\text{C}$, $L = 197\text{ mH}$, $R_g = 25\text{ }\Omega$, $I_{AS} = 1.7\text{ A}$ (see fig. 12)
- $I_{SD} \leq 10\text{ A}$, $dI/dt \leq 90\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 175\text{ }^{\circ}\text{C}$
- 1.6 mm from case

THERMAL RESISTANCE RATINGS

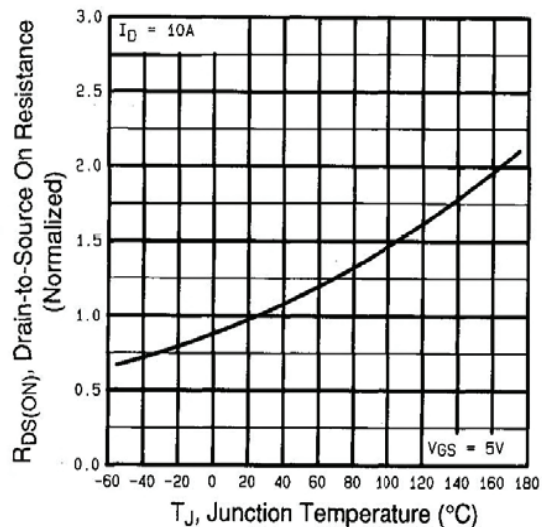
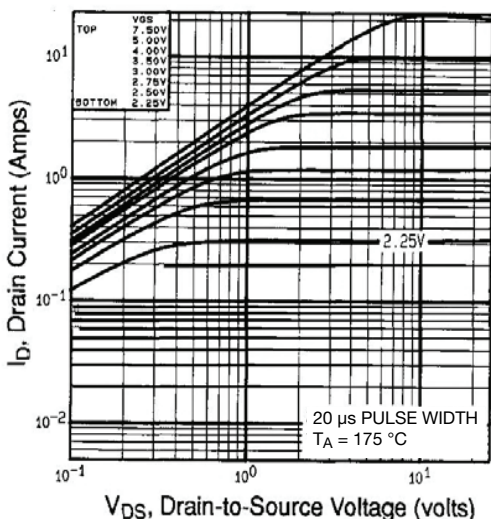
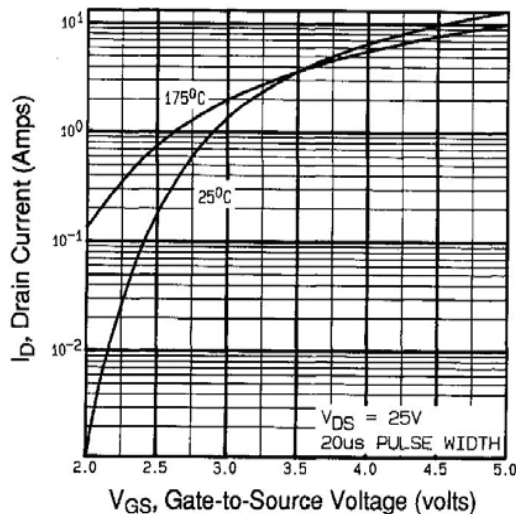
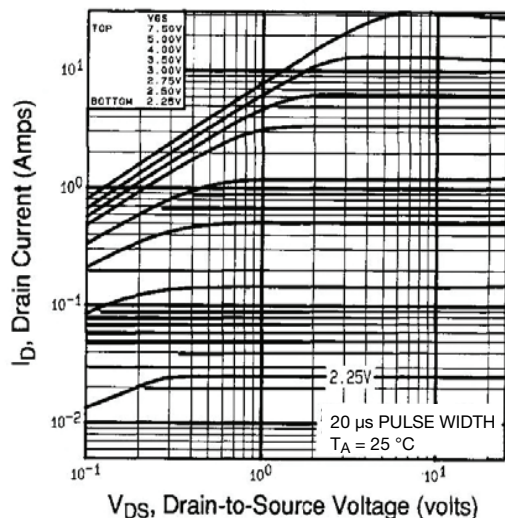
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	120	°C/W

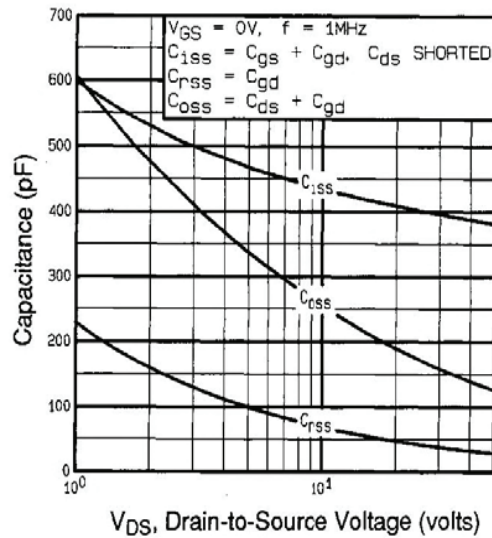
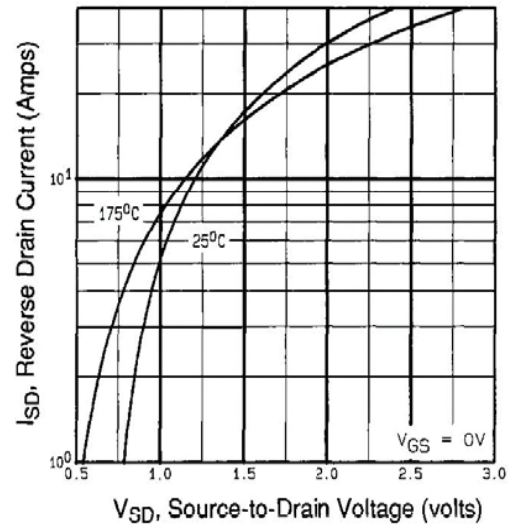
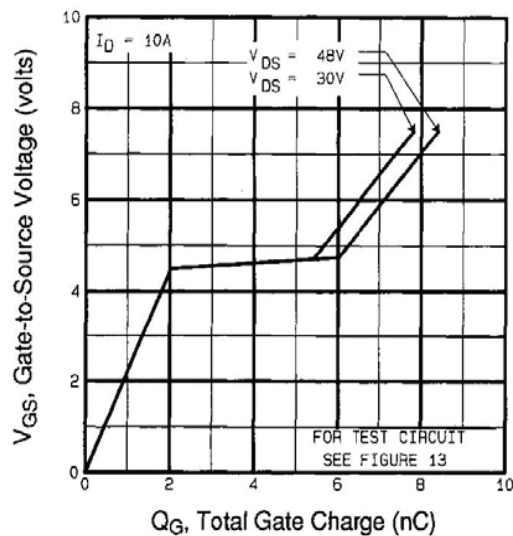
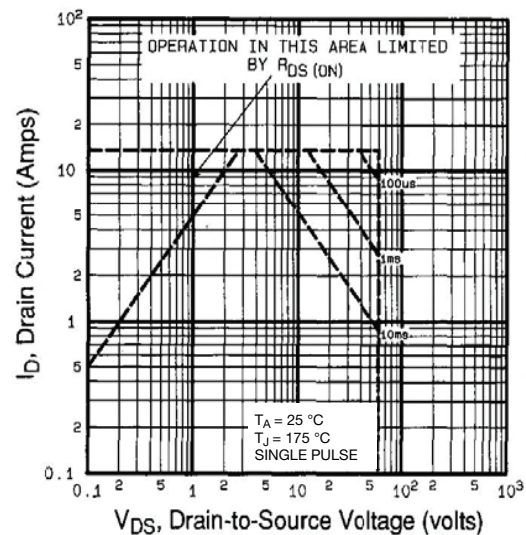
SPECIFICATIONS ($T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

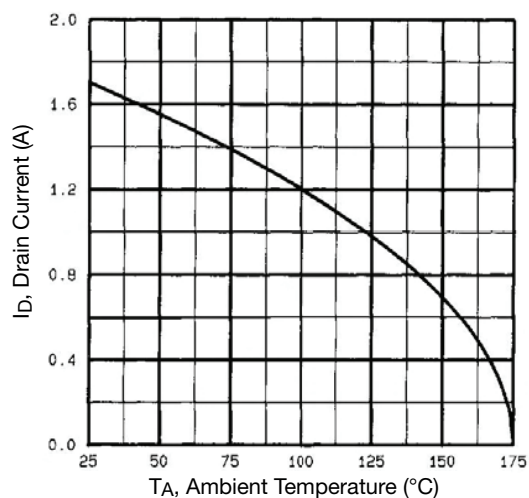
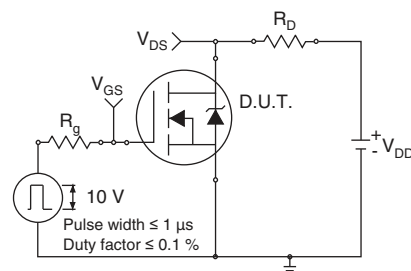
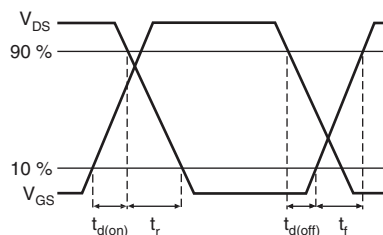
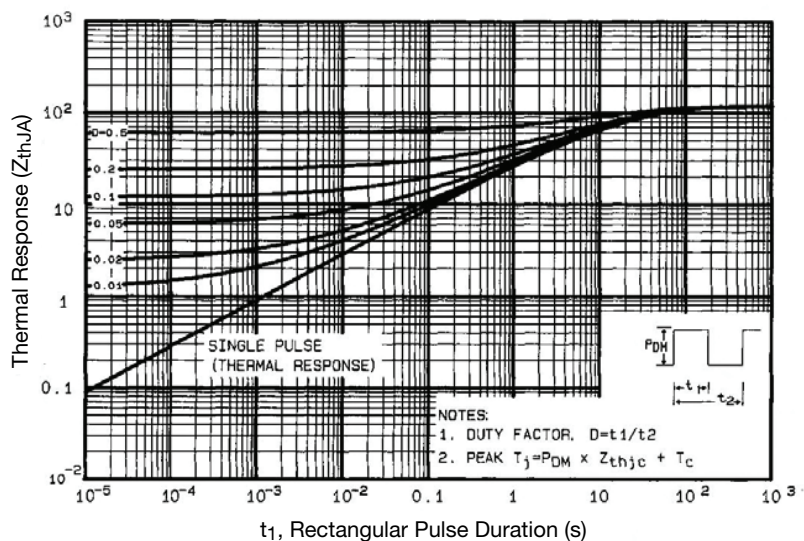
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		60	-	-	V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	Reference to 25 °C, I _D = 1 mA		-	0.070	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 10 V		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V		-	-	25	μA
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 150 °C		-	-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 5.0 V	I _D = 1.0 A ^b	-	-	0.20	Ω
		V _{GS} = 4.0 V	I _D = 0.85 A ^b	-	-	0.28	
Forward Transconductance	g _{fs}	V _{DS} = 25 V, I _D = 1.0 A ^b		1.9	-	-	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V V _{DS} = 25 V f = 1.0 MHz, see fig. 5		-	400	-	pF
Output Capacitance	C _{oss}			-	170	-	
Reverse Transfer Capacitance	C _{rss}			-	42	-	
Total Gate Charge	Q _g	V _{GS} = 5.0 V	I _D = 10 A, V _{DS} = 48 V see fig. 6 and 13 ^b	-	-	8.4	nC
Gate-Source Charge	Q _{gs}			-	-	2.6	
Gate-Drain Charge	Q _{gd}			-	-	6.4	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 30 V, I _D = 10 A R _g = 12 Ω, R _D = 2.8 Ω, see fig. 10 ^b		-	9.3	-	ns
Rise Time	t _r			-	110	-	
Turn-Off Delay Time	t _{d(off)}			-	17	-	
Fall Time	t _f			-	26	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact 		-	4.0	-	nH
Internal Source Inductance	L _S			-	6.0	-	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode 		-	-	1.7	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	14	
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 1.7 A, V _{GS} = 0 V ^b		-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 10 A, dI/dt = 100 A/μs ^b		-	93	130	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.34	0.65	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					

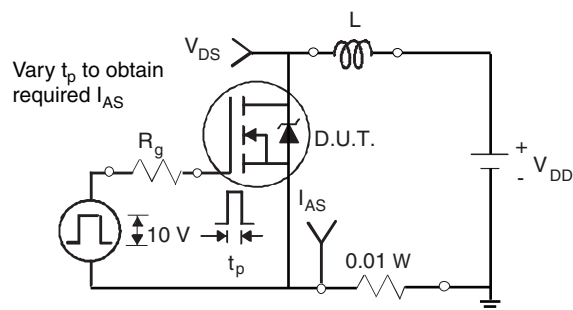
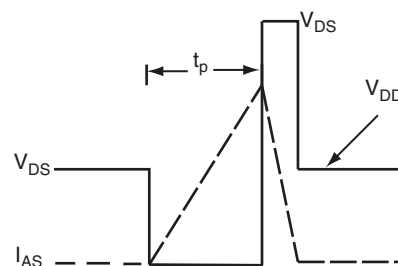
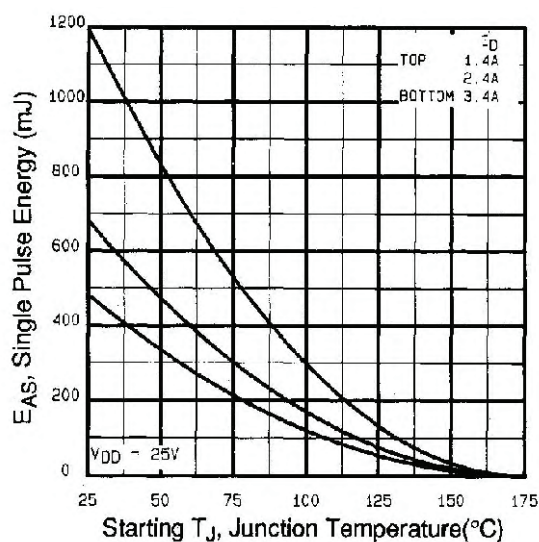
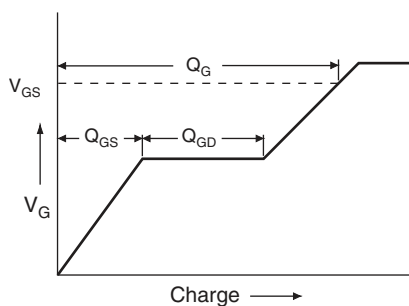
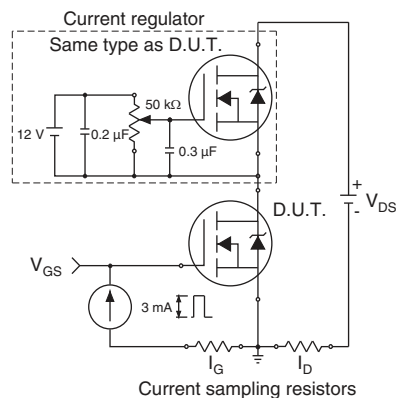
Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
b. Pulse width $\leq 300\text{ }\mu\text{s}$; duty cycle $\leq 2\%$

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage

Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Fig. 8 - Maximum Safe Operating Area


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

Fig. 10a - Switching Time Test Circuit

Fig. 10b - Switching Time Waveforms

Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

Fig. 12c - Maximum Avalanche Energy vs. Drain Current

Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit

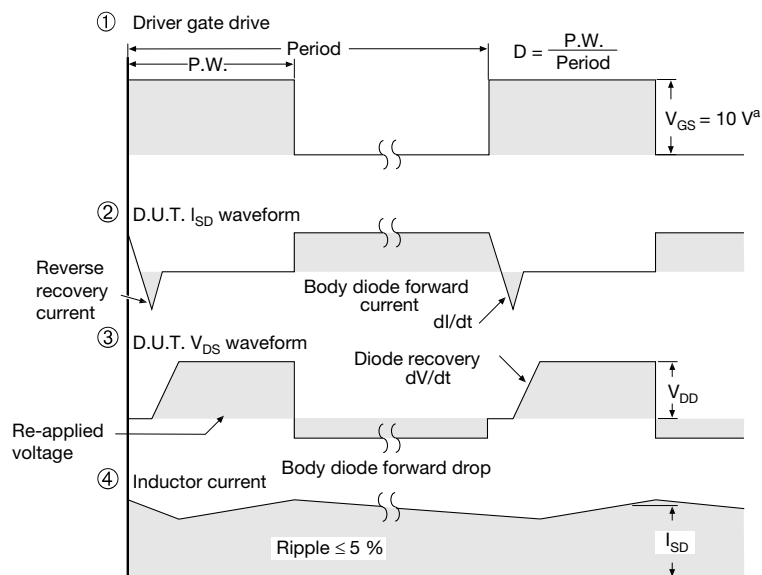
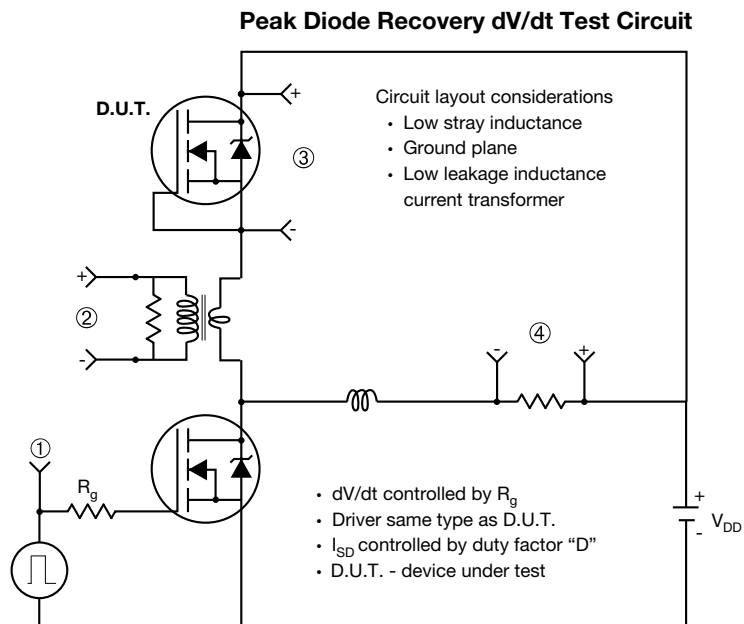


Fig. 14 - For N-Channel

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